

Solution brief

XENSIV[™] connected sensor kit Fast IoT experience enabled by XENSIV[™] sensors

The connected sensor kit solves the four biggest challenges of any IoT device development and deployment: sensing the world around us (sense), making sense of the raw data (compute), and connecting devices to the cloud (connect).

It is a feather compatible development kit for rapid prototyping and deployment of IoT devices. It consists of Infineon's highly accurate and precise XENSIV[™] sensors (60 GHz radar sensor, PAS CO2 and DPS368 pressure sensor), low power dual core microcontroller (PSoC[™] 6-2M), Bluetooth[®] and Wi-Fi as connectivity options within a software ecosystem provided through ModusToolbox[™].



XENSIV[™] connected sensor kit

Rapid IoT connect developer kit + BGT60TR13C wing + PAS CO2 wing







Rapid IoT connect developer kit + PAS CO2 wing



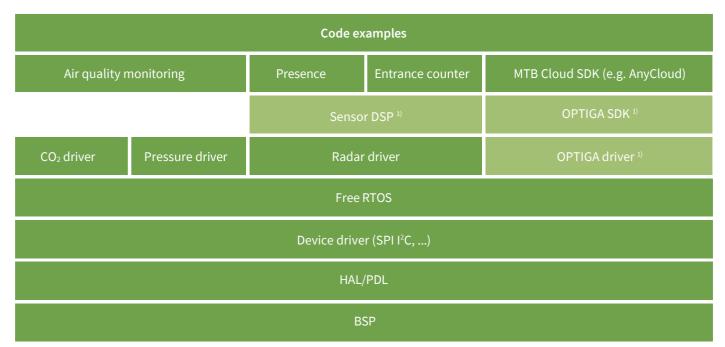
Key features

- Small form factor: 22.5 x 63 x 30 mm
 feather compatible
- Flexibility Interchangeable sensor wing boards-stacked individually or combined
- > Sensors: XENSIV[™] 60 GHz radar, PAS CO2 and DPS368 pressure sensor
- > PSoC[™] 6-2M microcontroller
- Connectivity –dual-band
 (2.4 and 5.0 GHz) Wi-Fi and
 Bluetooth 5.0-compliant combo radio module
- Security OPTIGA[™] Trust M for secure authentication of IoT devices

Key benefits

- Rapid prototyping a connected sensor kit for fast development and deployment
- > One-stop-shop for any IoT device development based on XENSIV™ 60 GHz radar, PAS CO2 and DPS368 pressure sensor
- > Seamless integration to ModusToolbox[™] with application code examples and sensor drivers for faster go-to-market

Software stack in ModusToolbox™



1) Coming soon

Sensors

> XENSIV[™] PAS CO2, BGT60TR13C radar and DPS368 pressure sensor

Microcontroller and connectivity

> CYSBSYS-RP01 – Rapid IoT module (FCC and CE certified module) (PSoC[™] 62M MCU (Cortex M4F/M0+) + Wi-Fi-Bluetooth[®] Combo)

Security

> OPTIGA[™] Trust M

Kit certification

> CE

Target applications

 Smart home devices, smart appliances, building management and control





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